



TARGET THICKNESS: 0.093"
NUMBER OF LAYERS: 14

MULTILAYER PCB CONSTRUCTION SHEET

If there are max thickness requirements beyond +/- .10% overall - non-standard

14 Layer StackUp (0.093") L14-093-1ozHoz		Thickness (inches)
Layer 1	.5 oz foil plated to approximate* thickness 0.0017"	0.0017
Prepreg	Bonding ply (1x1080, 1x2116) Average Dielectric Constant 4.5	0.0064
Layer 2	1 oz foil thickness	0.0014
Core	Laminate Core Average Dielectric Constant 4.5	0.005
Layer 3	1 oz foil thickness	0.0014
Prepreg	Bonding ply (1x1080, 1x2116) Average Dielectric Constant 4.5	0.0064
Layer 4	1 oz foil thickness	0.0014
Core	Laminate Core Average Dielectric Constant 4.5	0.005
Layer 5	1 oz foil thickness	0.0014
Prepreg	Bonding ply (1x1080, 1x2116) Average Dielectric Constant 4.5	0.0064
Layer 6	1 oz foil thickness	0.0014
Core	Laminate Core Average Dielectric Constant 4.5	0.005
Layer 7	1 oz foil thickness	0.0014
Prepreg	Bonding ply (1x1080, 1x2116) Average Dielectric Constant 4.5	0.0064
Layer 8	1 oz foil thickness	0.0014
Core	Laminate Core Average Dielectric Constant 4.5	0.005
Layer 9	1 oz foil thickness	0.0014
Prepreg	Bonding ply (1x1080, 1x2116) Average Dielectric Constant 4.5	0.0064
Layer 10	1 oz foil thickness	0.0014
Core	Laminate Core Average Dielectric Constant 4.5	0.005
Layer 11	1 oz foil thickness	0.0014
Prepreg	Bonding ply (1x1080, 1x2116) Average Dielectric Constant 4.5	0.0064
Layer 12	1 oz foil thickness	0.0014
Core	Laminate Core Average Dielectric Constant 4.5	0.005
Layer 13	1 oz foil thickness	0.0014
Prepreg	Bonding ply (1x1080, 1x2116) Average Dielectric Constant 4.5	0.0064
Layer 14	.5 oz foil plated to approximate* thickness 0.0024"	0.0017
*Thickness does not include soldermask or surface finish"		0.0933

NOTES: